



DMN24H11DS

Product Summary

BV _{DSS}	Rds(on)	ID T _A = +25°C		
240V	11Ω @ VGS = 10V	0.27A		
240V	12Ω @ V _{GS} = 4.5V	0.26A		

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

Applications

- DC-DC converters
- Power-management functions
- Battery-operated systems and solid-state relays
- Drivers: relays, solenoids, lamps, hammers, displays, memories, transistors, etc.

N-CHANNEL ENHANCEMENT MODE MOSFET

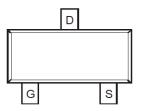
Features and Benefits

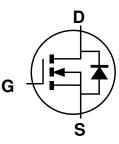
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface-Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>DMN24H11DSQ</u>)

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
 Lead Free Plating (Matte Tin Finish Annealed over Alloy 42
 Leadframe). (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)







Equivalent Circuit

Top View

Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Nulliger	Раскауе	Qty.	Carrier	
DMN24H11DS-7	SOT23	3,000	Tape & Reel	
DMN24H11DS-13	SOT23	10,000	Tape & Reel	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

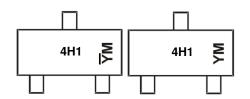
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Notes:



Marking Information



 $\begin{array}{l} 4\text{H1} = \text{Product Type Marking Code} \\ \underline{YM} = \text{Date Code Marking for SAT (Shanghai Assembly/ Test Site)} \\ \overline{YM} = \text{Date Code Marking for CAT (Chengdu Assembly/ Test Site)} \\ Y \text{ or } \overline{Y} = \text{Year (ex: K = 2023)} \\ M = \text{Month (ex: 9 = September)} \end{array}$

Date Code Key

Year	2014	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	В	-	K	L	М	Ν	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
mornar	Vull	100	IVICI	ΠPi	ivia y	oun	Jui	Aug	Sep	001	NOV	Dee

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	n-Source Voltage				V
Gate-Source Voltage	VGSS	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	lD	0.27 0.22	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle ≦1%)	Ідм	0.8	A		
Maximum Body Diode Continuous Current (Note 6)	ls	0.27	A		
Pulsed Body Diode Continuous Current (10µs Pulse	lsм	0.8	A		
Peak Diode Recovery dv/dt			dv/dt	6.0	V/ns

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation	(Note 5)	D-	0.75	W	
	(Note 6)	PD	1.2		
Thermal Desistance Innetion to Ambient	(Note 5)	P	166		
Thermal Resistance, Junction to Ambient	(Note 6)	R _{0JA}	104	°C/W	
Thermal Resistance, Junction to Case (Note 6)		Rejc	35		
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

 Notes:
 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.



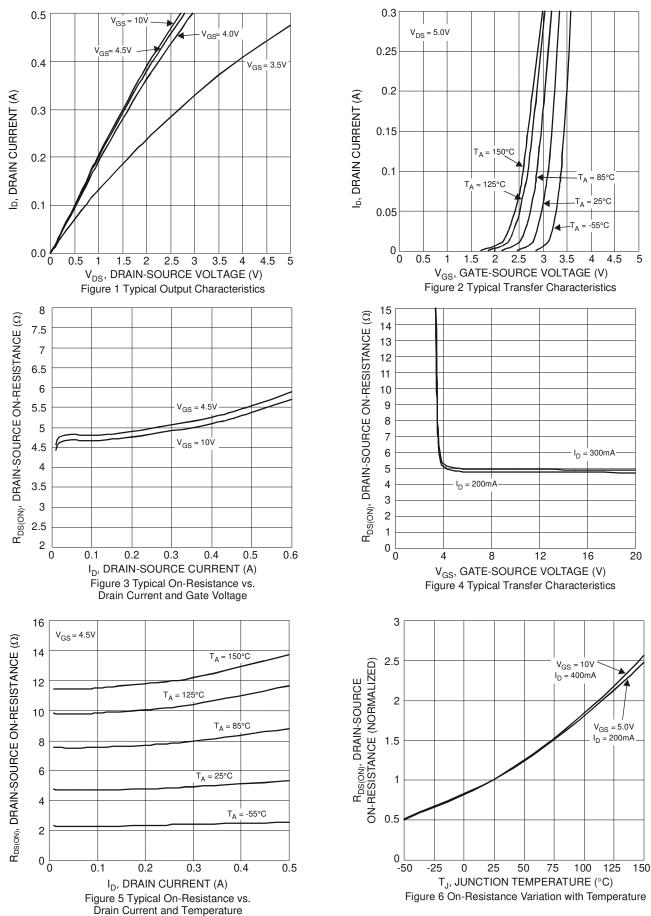
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	240	_		V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	100	nA	$V_{DS} = 240V, V_{GS} = 0V$
Gate-Body Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1.0	2.0	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Descent	_	3.7	11	Ω	$V_{GS} = 10V, I_D = 0.3A$
Static Drain-Source On-Resistance	RDS(ON)	_	4.0	12	12	$V_{GS} = 4.5V, I_D = 0.2A$
Diode Forward Voltage	VSD	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 0.1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		76.8	_		$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Output Capacitance	Coss	_	6.9	_	pF	
Reverse Transfer Capacitance	Crss	_	4.1	_		
Gate Resistance	Rg	_	17	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	_	3.7	_		
Gate-Source Charge	Qgs		0.3		nC	V _{DS} = 192V, V _{GS} = 10V, I _D = 0.1A
Gate-Drain Charge	Q _{gd}	_	2.1	_		ID = 0.1A
Turn-On Delay Time	tD(on)	_	4.8	_		
Turn-On Rise Time	tr		4.7			V _{DS} = 120V, I _D = 0.1A,
Turn-Off Delay Time	t _{D(off)}		17.5		ns	$V_{GS} = 10V, R_G = 6.0\Omega$
Turn-Off Fall Time	tr		102.3		1	
Reverse Recovery Time	t _{rr}		45.6		ns	V _R = 100V, I _F = 1.0A,
Reverse Recovery Charge	Q _{rr}		51.6		nC	di/dt = 100A/µs

Notes:7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.

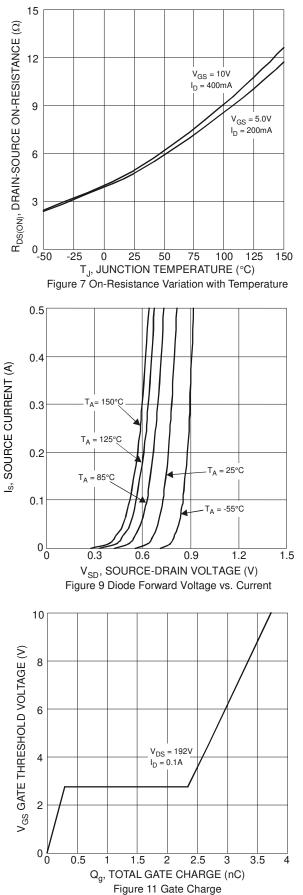


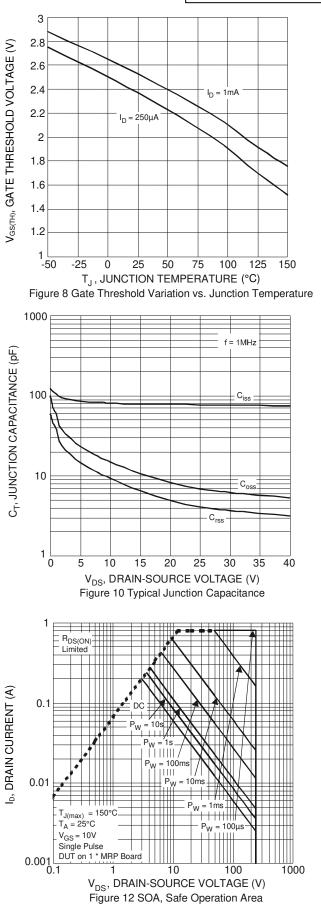
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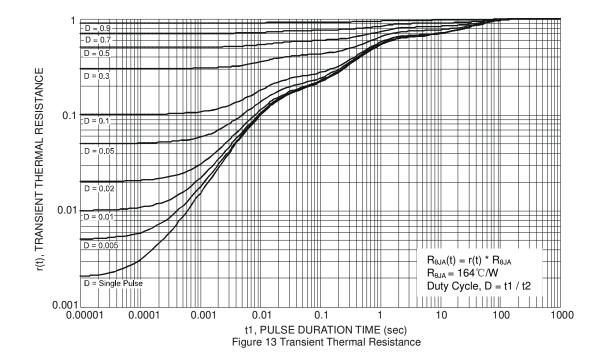






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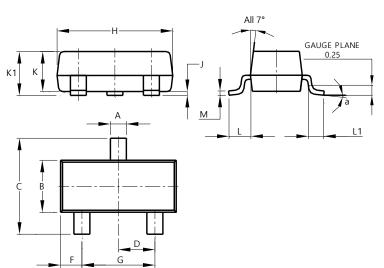






Package Outline Dimensions

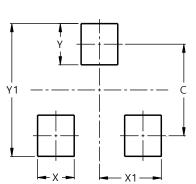
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78 2.05		1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890 1.00		0.975					
K1	0.903 1.10 1.0		1.025					
L	0.45	0.61	0.55					
L1	0.25	0.25 0.55						
М	0.085	0.085 0.150 0						
а	0°	8°						
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

SOT23

Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Y	0.9				
Y1	2.9				



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